

IN THE CLAIMS

Please amend the claims as follows:

Claims 1-4 (Canceled).

Claim 5 (Currently Amended): A cold-shrinkable type ~~rubber~~ elastic sleeve that is tube shaped, comprising:

an internal semiconductive layer that includes an elastic material and a semiconductive material;

a reinforced insulation layer that is formed around the internal semiconductive layer to reinforce the internal semiconductive layer;

an external semiconductive layer that includes an elastic material and a semiconductive material, ~~and is formed~~ the semiconductive layer being molded around the reinforced insulation layer;

two stress-relief cones, wherein one stress-relief cone is formed at each end of the cold-shrinkable type ~~rubber~~ elastic sleeve; and

two edge-cut sections, each edge-cut section is formed near each of the stress-relief cones by edge-cutting the external semiconductive layer in a direction of a length of the cold-shrinkable type ~~rubber~~ elastic sleeve.

Claim 6 (Currently Amended): The cold-shrinkable type ~~rubber~~ elastic sleeve according to claim 5, wherein the external semiconductive layer covers the stress-relief cones through the reinforced insulation layer.

Claim 7 (Currently Amended): The cold-shrinkable type ~~rubber~~ elastic sleeve according to claim 5, wherein the external semiconductive layer is substantially cylindrical.

Claim 8 (Currently Amended): The cold-shrinkable type ~~rubber~~ elastic sleeve according to claim 5, wherein a thickness of the external semiconductive layer is substantially uniform.

Claim 9 (Original): A method of manufacturing a cold-shrinkable type rubber sleeve, comprising:

forming a tube of an internal semiconductive layer with an elastic material and a semiconductive material;

forming a reinforced insulation layer around the internal semiconductive layer to reinforce the internal semiconductive layer;

forming an external semiconductive layer around the reinforced insulation layer with an elastic material and a semiconductive material;

forming a stress-relief cone at each end of the cold-shrinkable type rubber sleeve; and
insulating the external semiconductive layer from both the stress-relief cones.

Claim 10 (New): A cold-shrinkable type elastic sleeve that is tube shaped, comprising:

an internal semiconductor layer that includes an elastic material and a semiconductive material;

a reinforced insulation layer that is formed around the internal semiconductive layer to reinforce the internal semiconductive layer;

an external semiconductive layer that includes an elastic material and a semiconductive material, and is formed around the reinforced insulation layer;

two stress-relief cones, wherein one stress-relief cone is formed at each end of the cold-shrinkable type rubber sleeve; and

two edge-cut sections, each edge-cut section is formed near each of the stress-relief cones by edge-cutting the external semiconductive layer in a direction of a length of the cold-shrinkable type rubber sleeve, wherein the cold-shrinkable type elastic sleeve is supported on a disassemblable carrier in an expanded state.

Claim 11 (New): The cold-shrinkable type elastic sleeve according to claim 10, wherein the disassemblable carrier includes a disassemble carrier pipe.

Claim 12 (New): The cold-shrinkable type elastic sleeve according to claim 10, wherein the elastic material includes one material selected from the group consisting of ethylene-propylene rubber and silicone rubber.

Claim 13 (New): The cold-shrinkable type elastic sleeve according to claim 10, wherein the elastic material includes one material selected from the group consisting of ethylene-propylene rubber and silicone rubber.

Claim 14 (New): The cold-shrinkable type elastic sleeve according to claim 10, wherein the two edge-cut sections extend around an outer periphery of the reinforced insulation layer, and are free of the external semiconductive layer to expose a part of thereinforced insulation layer at each end of the reinforced insulation layer.

Claim 15 (New): The cold-shrinkable type elastic sleeve according to claim 10, wherein the two edge-cut sections extend around an outer periphery of the reinforced

insulation layer, and are free of the external semiconductive layer to expose a part of the reinforced insulation layer at each end of the reinforced insulation layer.

Claim 16 (New): A cold-shrinkable type elastic sleeve that is tube shaped, comprising:

an internal semiconductive layer that includes an elastic material and a semiconductive material;

a reinforced insulation layer that is formed around the internal semiconductive layer to reinforce the internal semiconductive layer;

an external semiconductive layer that includes an elastic material and a semiconductive material, and is formed around the reinforced insulation layer; and

two stress-relief cones, wherein one stress-relief cone is formed at each end of the cold-shrinkable type rubber sleeve, and a part of the reinforced insulation layer extends around each of the stress-relief cone to embed one end of each stress-relief cone therein,

wherein at least a portion of the part of the reinforced insulation layer that extends around each of the stress-relief cones in a direction of a length of the cold-shrinkable type elastic sleeve is uncovered by the external semiconductive layer to be exposed, and

wherein the cold-shrinkable type elastic sleeve is supported on a disassemblable carrier in an expanded state.